

Number of contacts 20, 26, 28, 36, 40, 50, 68, 80, 100

Pitch 1.27 mm

Working current 1 A

Working voltage 240 V ~

Test voltage  $U_{r.m.s.}$  750 V

Contact resistance  $\leq 30 \text{ m}\Omega$

Insulation resistance  $\geq 10^3 \text{ M}\Omega$

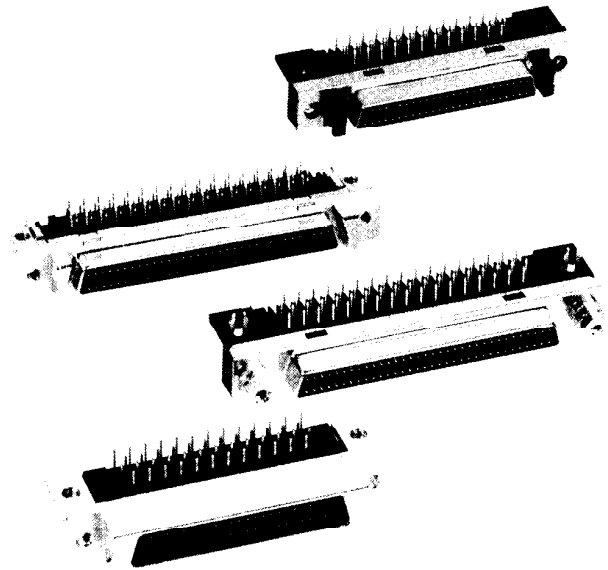
Temperature range  $-55 \text{ }^\circ\text{C} \dots +105 \text{ }^\circ\text{C}$

**Terminations**

Solder cup AWG 24  
Insulation max.  $\varnothing 1 \text{ mm}$

Solder pins Straight for PCB holes  
min.  $\varnothing 0.74 \text{ mm}$   
Angled  $90^\circ$  for PCB holes  
min.  $\varnothing 0.74 \text{ mm}$

Insulation displacement Discret wire  
AWG 28 to AWG 30  
max. section:  $0.089 \text{ mm}^2$   
min. section:  $0.050 \text{ mm}^2$   
Insulation  $\varnothing$  min.  $0.50 \text{ mm}$   
 $\varnothing$  max.  $0.88 \text{ mm}$   
Flat cable  
AWG 30 pitch  $0.635 \text{ mm}$



**Materials**

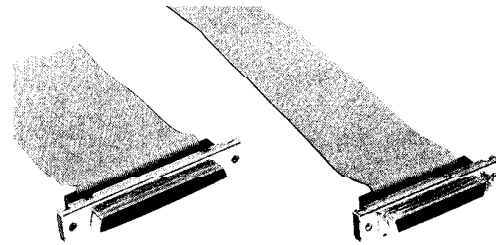
Moulding Thermoplastic resin  
glass-fibre filled UL 94-V0  
Liquid Cristal Polymer (LCP)  
for SCSI 3, straight

Contacts Copper alloy

Contact plating Selectively gold-plated

Metal shell Die cast zamac or stamped  
steel, nickel-plated

Hoods Die cast zamac, nickel-plated  
Thermoplastic resin  
nickel-plated, steel insert



**Press-in**

Insertion process Flat rock

Maximum press-in force  
per contact 100 N

Minimum push out force  
per contact 15 N

Number of repairs 2

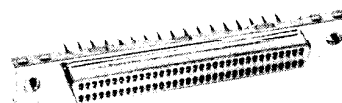
Recommended Board  
characteristics finished hole  $\varnothing 0.6 \begin{matrix} +0.07 \\ -0.05 \end{matrix} \text{ mm}$

Drilled hole size  $\varnothing 0.7 / 0.74 \text{ mm}$

Cu 30 – 60  $\mu\text{m}$

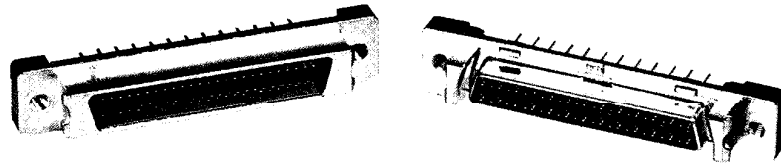
Sn 5 – 20  $\mu\text{m}$

Board thickness 1.6 – 3.2 mm



Number of contacts

# 20-68

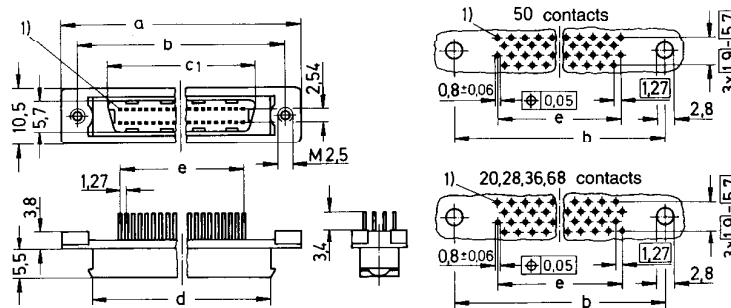


## Connector solder pins, straight

Identification	No. of contacts	Part No.	
		Male connector	Female connector
Male and female connector with straight solder pins	20	60 01 020 5202	60 01 020 5102
	26	60 01 026 5202 *	60 01 026 5102
	28	60 01 028 5202	60 01 028 5102
	36	60 01 036 5202	60 01 036 5102 *
	40	60 01 040 5202 *	60 01 040 5102
	50	60 01 050 5202	60 01 050 5102
	68	60 01 068 5202	60 01 068 5102

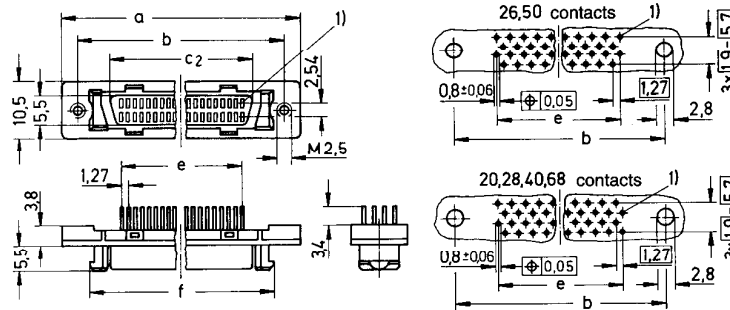
### Male connector

Dimensions in mm

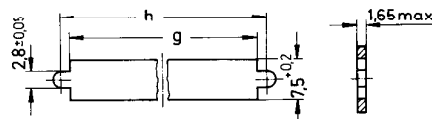


	a	b $\pm 0.1$	c <sub>1</sub>	c <sub>2</sub>	d	e	f	g	h
20	33.40	27.43	15.80	15.60	21.60	9 x 1.27 = 11.43	23.24	23.70	27.45
26	37.21	31.24	-	19.41	-	12 x 1.27 = 15.24	27.05	27.50	31.25
28	38.48	32.51	20.88	20.68	26.68	13 x 1.27 = 16.51	28.32	28.80	32.50
36	43.56	37.56	25.96	-	31.76	17 x 1.27 = 21.59	-	33.90	37.60
40	46.10	40.13	-	28.30	-	19 x 1.27 = 24.13	35.94	36.40	40.15
50	52.45	46.48	34.85	34.65	40.65	24 x 1.27 = 30.48	42.29	42.80	46.50
68	63.88	57.91	46.28	46.08	52.08	33 x 1.27 = 41.91	53.72	54.20	57.90

### Female connector



### Panel cut out

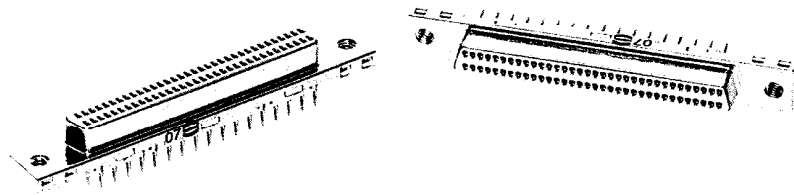


1) Contact number 1

\* Not yet developed

Number of contacts

**68**

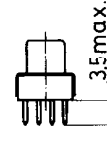
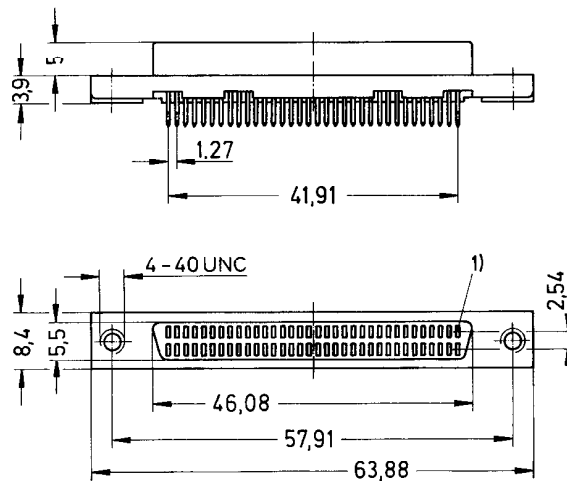


**Female connector solder and Press-in pins, straight**

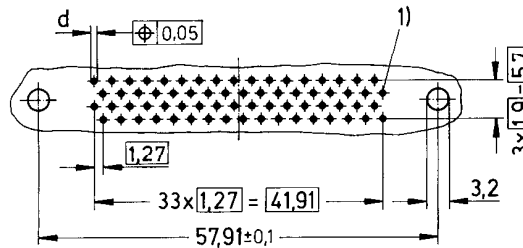
Identification	No. of contacts	Part No.
Female connector with straight pins	68	Solder 60 02 068 5120 Press-in 60 02 068 5320

**Female connector**

Dimensions in mm



**Board drillings**  
(Components side)



	d
Solder	0.8 ± 0.06
Press-in	0.6 ± $\begin{matrix} 0.07 \\ -0.05 \end{matrix}$

1) Contact number 1

Press in recommended characteristics finished trote	Ø 0.6 ± $\begin{matrix} 0.07 \\ -0.05 \end{matrix}$
Drilled hole size	Ø 0.71 / 0.74 mm
Cu	30-60 µm
Sn	5-20 µm
Board thickness	1.6-3.2 mm

Note: Moulding material LCP allowing reflow for SMC process

Tools see page 40